P-Channel 30-V (D-S) MOSFET

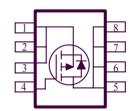
These miniature surface mount MOSFETs utilize High Cell Density process. Low r_{DS(on)} assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are PWMDC-DC converters, power management in portable and battery-powered products such as computers, printers, battery charger, telecommunication power system, and telephones power system.

| • | Low r _{DS(on)} Provides Higher Efficiency and |
|---|--------------------------------------------------------|
| | Extends Battery Life |

- Miniature SO-8 Surface Mount Package Saves Board Space
- High power and current handling capability
- Extended VGS range (±25) for battery pack applications

| PRODUCT SUMMARY | | | | |
|---------------------|------------------------|---------------------------|--|--|
| V _{DS} (V) | $r_{DS(on)} m(\Omega)$ | I _D (A) | | |
| -30 | $30 @ V_{GS} = -10V$ | 9.5 | | |
| -30 | $52 @ V_{GS} = -4.5V$ | 7.5 | | |





| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C UNLESS OTHERWISE NOTED) | | | | | |
|--------------------------------------------------------------------------|-------------------------------------|-----------------------------------|------------|-------|--|
| Parameter | | | Maximum | Units | |
| Drain-Source Voltage | | | -30 | V | |
| Gate-Source Voltage | | | ±25 | ٧ | |
| Continuous Drain Current ^a | T_{A} =25°C T_{A} =70°C | Τ_ | 9.5 | | |
| Continuous Drain Current | $T_A=70^{\circ}C$ | 1D | 8.3 | A | |
| Pulsed Drain Current ^b | | I_{DM} | ±50 | | |
| Continuous Source Current (Diode Conduction) ^a | | I_S | -2.1 | A | |
| D : a | $T_A=25^{\circ}C$ | D | 3.1 | W | |
| Power Dissipation ^a | $T_A=25^{\circ}C$ $T_A=70^{\circ}C$ | LD | 2.6 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|------------------------------------------|-------------|-----------------|-------|------|--|--|
| Parameter | Symbol | Maximum | Units | | | |
| Maximum Junction-to-Case ^a | t <= 5 sec | $R_{	heta JC}$ | 25 | °C/W | | |
| Maximum Junction-to-Ambient ^a | t <= 10 sec | $R_{\theta JA}$ | 50 | °C/W | | |

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

| SPECIFICATIONS (T _A = 25°C UNLESS OTHERWISE NOTED) | | | | | | | |
|---------------------------------------------------------------|----------------------|-------------------------------------------------------------------------------------------------------|--------|------|------|--------|--|
| Parameter | Symbol | T4 C #4 | Limits | | | T 1 34 | |
| rarameter | Symbol | Test Conditions | Min | Тур | Max | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V}, I_D = -250 \text{ uA}$ | -30 | | | V | |
| Gate-Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = -250 \text{ uA}$ | -1 | -1.6 | -3 | V | |
| Gate-Body Leakage | Igss | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$ | | | ±100 | nA | |
| Zara Cata Valtaga Drain Current | IDSS | $V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$ | | | -1 | uA | |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$ | | | -5 | | |
| On-State Drain Current ^A | I _{D(on)} | $V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$ | -50 | | | A | |
| | | $V_{GS} = -10 \text{ V}, I_D = -9.5 \text{ A}$ | | 24 | 30 | | |
| Drain-Source On-Resistance ^A | TDS(on) | $V_{GS} = -4.5 \text{ V}, I_D = -7.5 \text{ A}$ | | 44 | 52 | mΩ | |
| | | $V_{GS} = -10 \text{ V}, I_D = -9.5 \text{ A}, TJ = 55^{\circ}\text{C}$ | | 29 | 36 | | |
| Forward Tranconductance ^A | gs | $V_{DS} = -15 \text{ V}, I_D = -9.5 \text{ A}$ | | 31 | | S | |
| Diode Forward Voltage | V_{SD} | $I_S = -2.1 \text{ A}, V_{GS} = 0 \text{ V}$ | | -0.7 | -1.2 | V | |
| Dynamic ^b | | | | | - | | |
| Total Gate Charge | Qg | V 15 V V 10 V | | 15 | 26 | | |
| Gate-Source Charge | Qgs | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V},$ $I_{D} = -9.5 \text{ A}$ | | 5.8 | | nC | |
| Gate-Drain Charge | Qgd | | | 12 | | | |
| Switching | | | | | | | |
| Turn-On Delay Time | td(on) | | | 15 | 26 | | |
| Rise Time | tr | $V_{DD} = -15 \text{ V}, R_L = 15 \Omega, ID = -1 \text{ A},$ $VGEN = -10 \text{ V}, RG = 6\Omega$ | | 12 | 21 | nS | |
| Turn-Off Delay Time | td(off) | | | 62 | 108 | | |
| Fall-Time | t_{f} | | | 46 | 71 | | |

Notes

- a. Pulse test: $PW \le 300us duty cycle \le 2\%$.
- b. Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics (P-Channel)

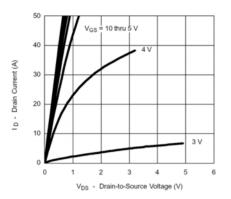


Figure 1. On-Region Characteristics

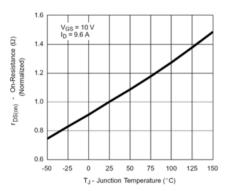


Figure 3. On-Resistance Variation with Temperature

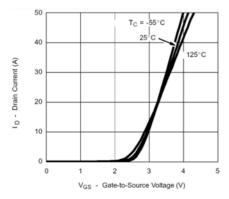


Figure 5. Transfer Characteristics

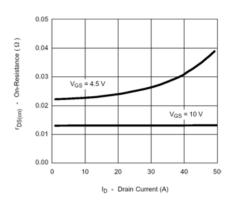


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

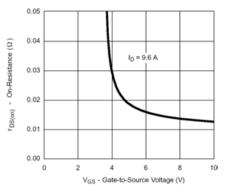


Figure 4. On-Resistance Variation with Gate to Source Voltage

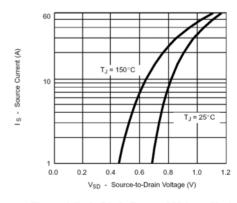


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Typical Electrical Characteristics (P-Channel)

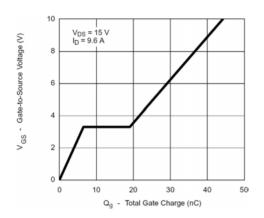


Figure 7. Gate Charge Characteristics

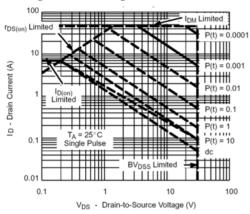


Figure 9. Maximum Safe Operating Area

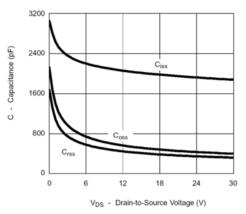


Figure 8. Capacitance Characteristics

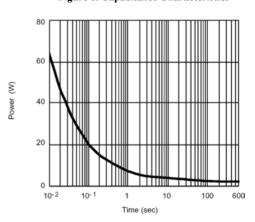


Figure 10. Single Pulse Maximum Power Dissipation

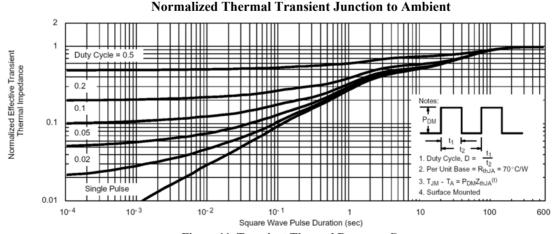
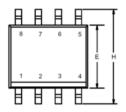
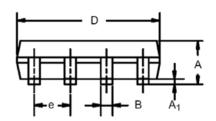


Figure 11. Transient Thermal Response Curve

Package Information

SO-8: 8LEAD





| | MILLIN | IETERS | INC | HES |
|----------------|--------------------|--------|--------|-------|
| Dim | Min | Max | Min | Max |
| Α | 1.35 | 1.75 | 0.053 | 0.069 |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 |
| В | 0.35 | 0.51 | 0.014 | 0.020 |
| С | 0.19 | 0.25 | 0.0075 | 0.010 |
| D | 4.80 | 5.00 | 0.189 | 0.196 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| е | 1.27 BSC 0.050 BSC | | | BSC |
| Н | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.020 |
| L | 0.50 | 0.93 | 0.020 | 0.037 |
| q | 0° | 8° | 0° | 8° |

